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PTO/SB/21 (08-00)

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TRANSMITTAL FORM (to be used for all correspondence after initial filing)	Application Number	09/352,194	
	Filing Date	July 13, 1999	
	First Named Inventor	Shunpei YAMAZAKI et al.	
	Group Art Unit	2823	
	Examiner Name	F. TOLEDO	
Total Number of Pages in This Submission		Attorney Docket Number	740756-1998

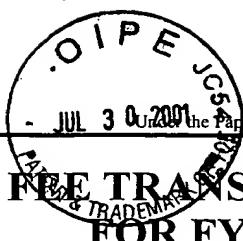
ENCLOSURES (check all that apply)		
<input checked="" type="checkbox"/> Fee Transmittal Form <input checked="" type="checkbox"/> Fee Attached <input checked="" type="checkbox"/> Amendment / Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application) <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s) _____	<input type="checkbox"/> After Allowance Communication to Group <input type="checkbox"/> Request for Drawing Change Approval Letter <div style="text-align: center;">RECEIVED AUG - 3 2001 TECHNOLOGY CENTER 2800</div>
Remarks		

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT	
Firm or Individual name	Luan C. Do Nixon Peabody LLP 8180 Greensboro Drive Suite 800 McLean, VA 22012
Signature	
Date	July 23, 2001

CERTIFICATE OF MAILING		
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C



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Patent fees are subject to annual revision.

TOTAL AMOUNT OF PAYMENT **\$480.00**

Complete if Known

Application Number 09/352,194
Filing Date July 13, 1999
First Named Inventor Shunpei YAMAZAKI et al
Examiner Name F. TOLEDO
Group Art Unit 2823
Attorney Docket No. 740756-1998

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METHOD OF PAYMENT

1. ☒ The Commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Deposit Account Number 19-2380

Deposit Account Name Nixon Peabody LLP

☒ Charge Any Additional Fee Required Under 37 CFR 1.16 and 1.17

☐ Applicant claims small entity status. See 37 CFR 1.27

2. ☒ Payment Enclosed:

☒ Check ☐ Credit Card ☐ Money Order ☐ Other

FEE CALCULATION

1. BASIC FILING FEE

Large Entity Fee Code	Small Entity Fee Code	Fee Description	Fee Paid
101	201	Utility filing fee	
106	206	Design filing fee	
107	207	Plant filing fee	
108	208	Reissue filing fee	
114	214	Provisional filing fee	

SUBTOTAL (1) (\$)

2. EXTRA CLAIM FEES

Total Claims 20 = Extra Claims 6 X Fee from below 480 = Fee Paid 480.00

Large Entity Fee Code	Small Entity Fee Code	Fee Description	Fee Paid
103	203	Claims in excess of 20	
102	202	Independent claims in excess of 3	
104	204	Multiple dependent claim, if not paid	
109	209	** Reissue independent claims over original patent	
110	210	** Reissue claims in excess of 20 and over original patent	

SUBTOTAL (2)

\$480.00

*or number previously paid, if greater; For Reissues, see above

FEE CALCULATION (continued)

3. ADDITIONAL FEES

Large Entity Fee Code	Small Entity Fee Code	Fee Description	Fee Paid
105	205	Surcharge - late filing fee or oath	
127	227	Surcharge - late provisional filing fee or cover sheet	
139	239	Non-English transaction	
147	247	For filing a request for <i>ex parte</i> reexamination	
112	212	Requesting publication of SIR prior to Examiner action	
113	213	Requesting publication of SIR after Examiner action	
115	215	Extension for reply within first month	
116	216	Extension for reply within second month	
117	217	Extension for reply within third month	
118	218	Extension for reply within fourth month	
128	228	Extension for reply within fifth month	
119	219	Notice of Appeal	
120	220	Filing a brief in support of an appeal	
121	221	Request for oral hearing	
138	238	Petition to institute a public use proceeding	
140	240	Petition to revive - unavoidable	
141	241	Petition to revive - unintentional	
142	242	Utility issue fee (or reissue)	
143	243	Design issue fee	
144	244	Plant issue fee	
122	222	Petitions to the Commissioner	
123	223	Petitions related to provisional applications	
126	226	Submission of Information Disclosure Stmt	
581	281	Recording each patent assignment per property (times number of properties)	
146	246	Filing a submission after final rejection (37 CFR § 1.129(a))	
149	249	For each additional invention to be examined (37 CFR § 1.29(b))	
179	279	Request for Continued Examination (RCE)	
169	269	Request for continued examination of a design application	

Other fee (specify)

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SUBMITTED BY

Name (Print/Type) Luan C. Do
Registration No. 38,434
Telephone 703-790-9110
Signature
Date July 23, 2001

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AUGUST 2001
PATENT
740756-1998
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of:

Shunpei YAMAZAKI et al.

Art Unit: 2823

Application No.: 09/352,194

Examiner: Fernando TOLEDO

Filed: July 13, 1999

CERTIFICATE OF MAILING

For: CRYSTALLINE SEMICONDUCTOR THIN FILM, METHOD OF FABRICATING THE SAME SEMICONDUCTOR DEVICE, AND METHOD OF FABRICATING THE SAME)

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AMENDMENT

Commissioner of Patents
Washington, D.C. 20231

July 23, 2001

Dear Sir:

In response to the Examiner's non-Final Office Action mailed April 23, 2001, please consider the following amendments and remarks in connection with the above-identified application.

IN THE CLAIMS:

Please cancel claims 6-35 without prejudice or disclaimer of the subject matter contained therein.

Please amend claim 5 to read as follows:

5. (Twice Amended) A method of manufacturing a semiconductor device comprising the steps of:

forming a semiconductor film comprising silicon over a substrate;
providing said semiconductor film with a catalytic element for facilitating a crystallization of said semiconductor film;
irradiating said semiconductor film with laser light in air for crystallizing said semiconductor film after providing said catalytic element;

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